

# Development Board EPC9001C Quick Start Guide

*40 V Half-Bridge with Gate Drive, Using EPC2015C*



DESCRIPTION

[www.epc-co.com](http://www.epc-co.com)

The EPC9001C development board is a 40 V maximum device voltage, 15 A maximum output current, half bridge with onboard gate drives, featuring the EPC2015C enhancement mode (eGaN®) field effect transistor (FET). The purpose of this development board is to simplify the evaluation process of the EPC2015C eGaN FET by including all the critical components on a single board that can be easily connected into any existing converter.

The EPC9001C development board is 2" x 1.5" and contains two EPC2015Cs eGaN FET in a half bridge configuration using

Texas Instruments LM5113 gate driver, supply and bypass capacitors. The board contains all critical components and layout for optimal switching performance. There are also various probe points to facilitate simple waveform measurement and efficiency calculation. A complete block diagram of the circuit is given in Figure 1.

For more information on the EPC2015Cs eGaN FET please refer to the datasheet available from EPC at [www.epc-co.com](http://www.epc-co.com). The data-sheet should be read in conjunction with this quick start guide.

Table 1: Performance Summary (TA = 25°C)

| SYMBOL           | PARAMETER                              | CONDITIONS                     | MIN  | MAX | UNITS |
|------------------|--|--------------------------------|------|-----|-------|
| V <sub>DD</sub>  | Gate Drive Input Supply Range          |                                | 7    | 12  | V     |
| V <sub>IN</sub>  | Bus Input Voltage Range                |                                |      | 28* | V     |
| V <sub>OUT</sub> | Switch Node Output Voltage             |                                |      | 40  | V     |
| I <sub>OUT</sub> | Switch Node Output Current             |                                |      | 15* | A     |
| V <sub>PWM</sub> | PWM Logic Input Voltage Threshold      | Input 'High'                   | 3.5  | 6   | V     |
|                  |  | Input 'Low'                    | 0    | 1.5 | V     |
|                  | Minimum 'High' State Input Pulse Width | VPWM rise and fall time < 10ns | 60   |     | ns    |
|                  | Minimum 'Low' State Input Pulse Width  | VPWM rise and fall time < 10ns | 200# |     | ns    |

\* Assumes inductive load, maximum current depends on die temperature – actual maximum current will be subject to switching frequency, bus voltage and thermal.  
 # Limited by time needed to 'refresh' high side bootstrap supply voltage.

Quick Start Procedure

Development board EPC9001C is easy to set up to evaluate the performance of the EPC2015C eGaN FET. Refer to Figure 2. for proper connect and measurement setup and follow the procedure below:

1. With power off, connect the input power supply bus to +V<sub>IN</sub> (J5, J6) and ground / return to -V<sub>IN</sub> (J7, J8).
2. With power off, connect the switch node of the half bridge OUT (J3, J4) to your circuit as required.
3. With power off, connect the gate drive supply to +V<sub>DD</sub> (J1, Pin-1) and ground return to -V<sub>DD</sub> (J1, Pin-2).
4. With power off, connect the input PWM control signal to PWM (J2, Pin-1) and ground return to any of the remaining J2 pins.
5. Turn on the gate drive supply – make sure the supply is between 7 V and 12 V range.
6. Turn on the bus voltage to the required value (do not exceed the absolute maximum voltage of 100 V on V<sub>OUT</sub>).
7. Turn on the controller / PWM input source and probe switching node to see switching operation.
8. Once operational, adjust the bus voltage and load PWM control within the operating range and observe the output switching behavior, efficiency and other parameters.
9. For shutdown, please follow steps in reverse.

NOTE. When measuring the high frequency content switch node (OUT), care must be taken to avoid long ground leads. Measure the switch node (OUT) by placing the oscilloscope probe tip through the large via on the switch node (designed for this purpose) and grounding the probe directly across the GND terminals provided. See Figure 3 for proper scope probe technique.

THERMAL CONSIDERATIONS

The EPC9001C development board showcases the EPC2015C eGaN FET. Although the electrical performance surpasses that for traditional silicon devices, their relatively smaller size does magnify the thermal management requirements. The EPC9001C is intended for bench evaluation with low ambient temperature and convection cooling. The addition of heat-sinking and forced air cooling can significantly increase the current rating of these devices, but care must be taken to not exceed the absolute maximum die temperature of 150°C.

NOTE. The EPC2015C development board does not have any current or thermal protection on board.

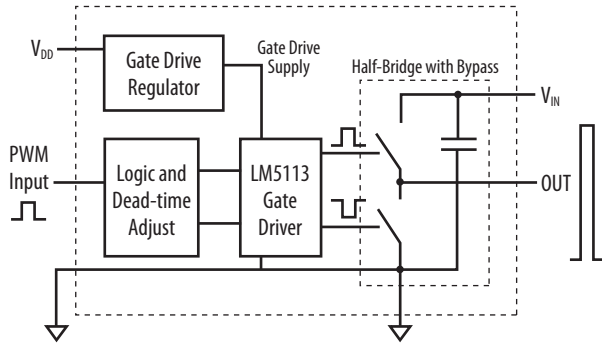


Figure 1: Block Diagram of EPC9001C Development Board

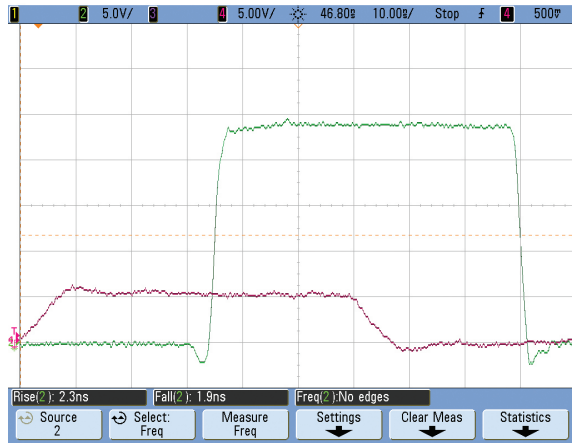


Figure 4: Typical Waveforms for  $V_{IN} = 24\text{ V}$  to  $1.2\text{ V}/15\text{ A}$  (500 kHz) Buck converter  
CH1:  $V_{PWM}$  Input voltage – CH3: ( $I_{OUT}$ ) Switch node current – CH4: ( $V_{OUT}$ ) Switch node voltage

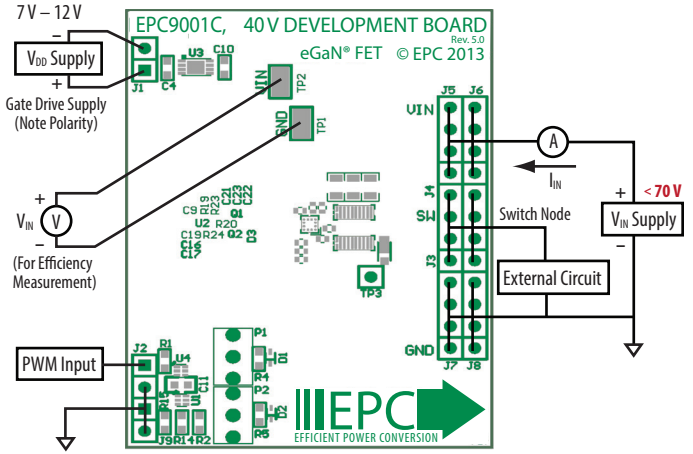


Figure 2: Proper Connection and Measurement Setup

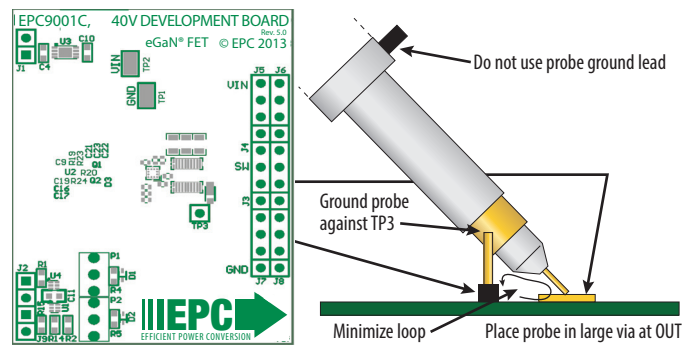
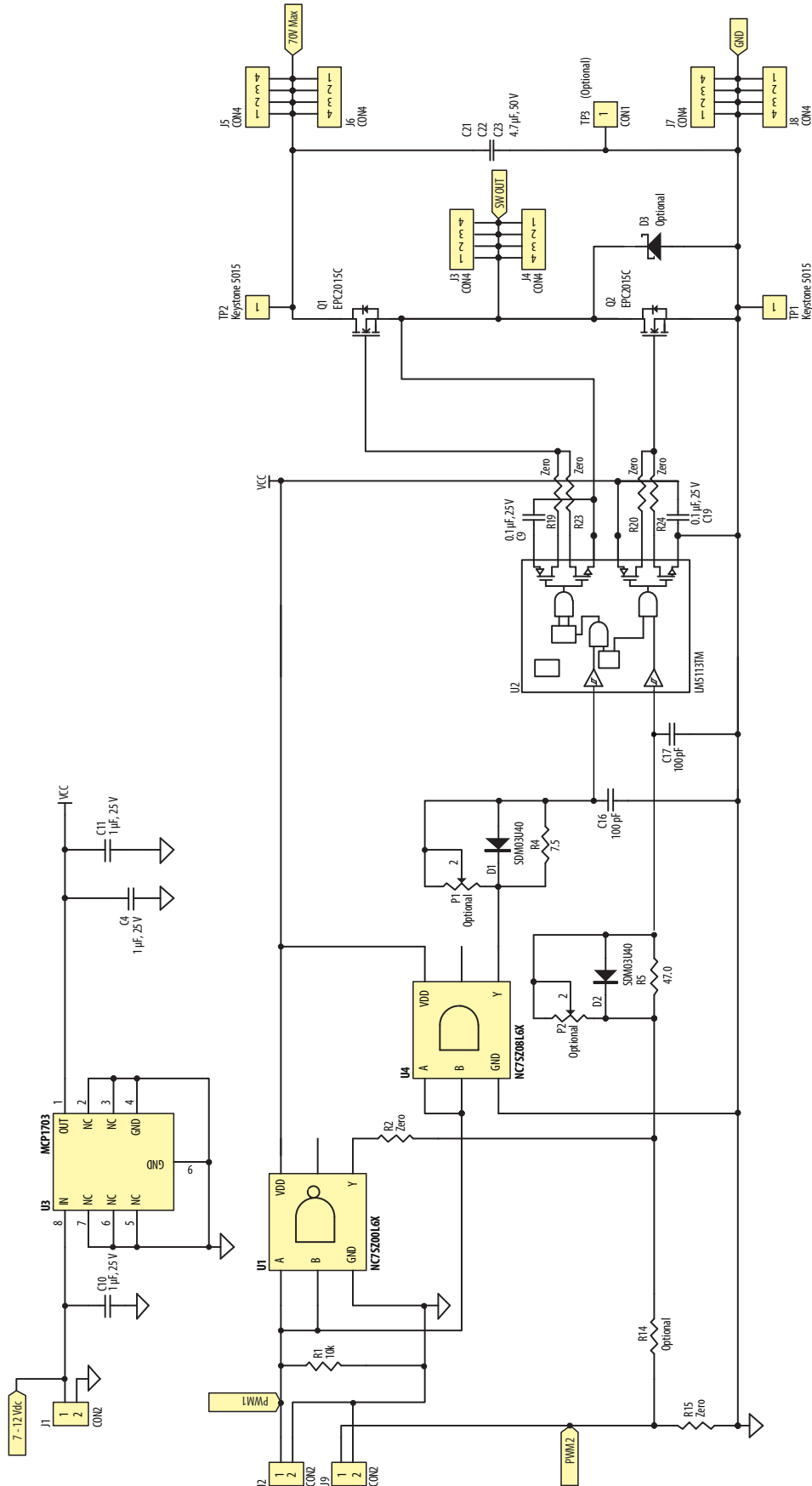


Figure 3: Proper Measurement of Switch Node – OUT

Table 2 : Bill of Material

| Item | Qty | Reference                    | Part Description                              | Manufacturer / Part #        |
|------|-----|------------------------------|---|------------------------------|
| 1    | 3   | C4, C10, C11,                | Capacitor, 1 $\mu\text{F}$ , 10%, 25 V, X5R   | Murata, GRM188R61E105KA12D   |
| 2    | 2   | C16, C17                     | Capacitor, 100 pF, 5%, 50 V, NP0              | Kemet, C0402C101K5GACTU      |
| 3    | 2   | C9, C19                      | Capacitor, 0.1 $\mu\text{F}$ , 10%, 25 V, X5R | TDK, C1005X5R1E104K          |
| 4    | 3   | C21, C22, C23                | Capacitor, 4.7 $\mu\text{F}$ , 10%, 50 V, X5R | TDK, C2012X5R1H475K125AB     |
| 5    | 2   | D1, D2                       | Schottky Diode, 30 V                          | Diodes Inc., SDM03U40-7      |
| 6    | 3   | J1, J2, J9                   | Connector                                     | 2pins of Tyco, 4-103185-0    |
| 7    | 1   | J3, J4, J5, J6, J7, J8       | Connector                                     | FCI, 68602-224HLF            |
| 8    | 2   | Q1, Q2                       | eGaN <sup>®</sup> FET                         | EPC, EPC2015C                |
| 9    | 1   | R1                           | Resistor, 10.0 K, 5%, 1/8 W                   | Stackpole, RMCF0603FT10K0    |
| 10   | 2   | R2, R15                      | Resistor, 0 Ohm, 1/8 W                        | Stackpole, RMCF0603ZT0R00    |
| 11   | 1   | R4                           | Resistor, 7.5 Ohm, 1%, 1/8 W                  | Stackpole, RMCF0603FT7R50    |
| 12   | 1   | R5                           | Resistor, 47 Ohm, 1%, 1/8 W                   | Stackpole, RMCF0603FT47R0    |
| 13   | 6   | R19, R20, R21, R22, R23, R24 | Resistor, 0 Ohm, 1/16 W                       | Stackpole, RMCF0402ZT0R00    |
| 14   | 2   | TP1, TP2                     | Test Point                                    | Keystone Elect, 5015         |
| 15   | 1   | TP3                          | Connector                                     | 1/40th of Tyco, 4-103185-0   |
| 16   | 1   | U1                           | I.C., Logic                                   | Fairchild, NC7SZ00L6X        |
| 17   | 1   | U2                           | I.C., Gate driver                             | Texas Instruments, LM5113TME |
| 18   | 1   | U3                           | I.C., Regulator                               | Microchip, MCP1703T-5002E/MC |
| 19   | 1   | U4                           | I.C., Logic                                   | Fairchild, NC7SZ08L6X        |
| 20   | 0   | R14                          | Optional Resistor                             |                              |
| 21   | 0   | D3                           | Optional Diode                                |                              |
| 22   | 0   | P1, P2                       | Optional Potentiometer                        |                              |



Development Board EPC9001C Schematic  
Rev 5.0

## For More Information:

Please contact [info@epc-co.com](mailto:info@epc-co.com)  
or your local sales representative

Visit our website:

[www.epc-co.com](http://www.epc-co.com)

Sign-up to receive  
EPC updates at  
[bit.ly/EPCupdates](http://bit.ly/EPCupdates)  
or text "EPC" to 22828



EPC Products are distributed through Digi-Key.

[www.digikey.com](http://www.digikey.com)

### Demonstration Board Notification

The EPC9001C boards are intended for product evaluation purposes only and is not intended for commercial use. As an evaluation tool, it is not designed for compliance with the European Union directive on electromagnetic compatibility or any other such directives or regulations. As board builds are at times subject to product availability, it is possible that boards may contain components or assembly materials that are not RoHS compliant. Efficient Power Conversion Corporation (EPC) makes no guarantee that the purchased board is 100% RoHS compliant. No Licenses are implied or granted under any patent right or other intellectual property whatsoever. EPC assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or any other intellectual property rights of any kind.

EPC reserves the right at any time, without notice, to change said circuitry and specifications.